Vishay Siliconix

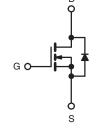


E Series Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V	0.039			
Q _g max. (nC)	362				
Q _{gs} (nC)	48				
Q _{gd} (nC)	98				
Configuration	Single				

TO-247AC





N-Channel MOSFET

FEATURES

- Low Figure-of-Merit (FOM) Ron x Qg
- Low Input Capacitance (Ciss)
- Reduced Switching and Conduction Losses
- Ultra Low Gate Charge (Qg)
- Avalanche Energy Rated (UIS)
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Switch Mode Power Supplies (SMPS)
- Power Factor Correction Power Supplies (PFC)
- Lighting
 - High-Intensity Discharge (HID)
 - Fluorescent Ballast Lighting
- Industrial
 - Welding
 - Induction Heating
 - Motor Drives
 - Battery Chargers
 - Renewable Energy
 - Solar (PV Inverters)

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free	SiHG73N60E-E3
Lead (Pb)-free and Halogen-free	SiHG73N60E-GE3

ABSOLUTE MAXIMUM RATINGS (T _C =	,			· · · · · · · · · · · · · · · · · · ·	
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	600		
Gate-Source Voltage		V	± 20	V	
Gate-Source Voltage AC (f > 1 Hz)		V _{GS}	30		
Continuous Drain Current (T _J = 150 °C)	$V_{GS} \text{ at } 10 \text{ V} \qquad \frac{T_{C} = 25 \text{ °C}}{T_{C} = 100 \text{ °C}}$		73	А	
	$T_{\rm C} = 100 ^{\circ}{\rm C}$	ID	46		
Pulsed Drain Current ^a		I _{DM}	236		
Linear Derating Factor			4.2	W/°C	
Single Pulse Avalanche Energy ^b		E _{AS}	2030	mJ	
Maximum Power Dissipation		P _D 520		W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 150	°C	
Drain-Source Voltage Slope	T _J = 125 °C	-0.77-0	37	N//	
Reverse Diode dV/dt ^d		dV/dt	8.4	V/ns	
Soldering Recommendations (Peak Temperature)	for 10 s		300 ^c	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 12 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D, \, dI/dt = 30$ A/µs, starting $T_J = 25 \ ^\circ C.$

S13-0935-Rev. C, 29-Apr-13

1 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 91482

Pb

- ROHS COMPLIANT HALOGEN

www.vishay.com

SiHG73N60E

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R _{thJA}	- 40			°C/M			
Maximum Junction-to-Case (Drain)	R _{thJC}	- 0.24				°C/W		
SPECIFICATIONS (T _J = 25 °C, u	nless otherwi	se noted)						
PARAMETER	SYMBOL	TEST		IONS	MIN.	TYP.	MAX.	UNI
Static								
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D =	250 µA	600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C,	I _D = 250 μA	-	0.65	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	V _{GS} , I _D =	250 µA	2	-	4	V
Gate-Source Leakage	I _{GSS}	Ň	/ _{GS} = ± 20	V	-	-	± 100	nA
			$V_{DS} = 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125 \text{ °C}$		-	-	10	μA	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V		_D = 36 A	-	0.032	0.039	Ω
Forward Transconductance	9 _{fs}	$V_{DS} = 40 \text{ V}, \text{ I}_{D} = 10 \text{ A}$		-	12	-	S	
Dynamic	010		. 5					
Input Capacitance	C _{iss}	<u> </u>		-	7700	-		
Output Capacitance	C _{oss}	- ,	V _{GS} = 0 V, V _{DS} = 100 V,		-	320	-	-
Reverse Transfer Capacitance	C _{rss}	f = 1 MHz		-	5	-	pF	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	$V_{DS} = 0$ V to 480 V, $V_{GS} = 0$ V		-	259	-		
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	907	-		
Total Gate Charge	Qg				-	241	362	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	I _D = 24	A, V _{DS} = 480 V	-	48	-	nC
Gate-Drain Charge	Q _{gd}				-	98	-	
Turn-On Delay Time	t _{d(on)}	V_{DD} = 480 V, I _D = 24 A, V _{GS} = 10 V, R _g = 10 Ω		-	63	95	- ns	
Rise Time	t _r			-	105	158		
Turn-Off Delay Time	t _{d(off)}			-	290	435		
Fall Time	t _f			-	120	180		
Gate Input Resistance	R _g	f = 1 MHz, open drain		-	1.52	-	Ω	
Drain-Source Body Diode Characteristic	s							
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	73		
Pulsed Diode Forward Current	I _{SM}			-	-	200	A	
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 36 A, V _{GS} = 0 V		-	0.9	1.2	V	
Reverse Recovery Time	t _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 24 \text{ A},$ dl/dt = 100 A/µs, V _R = 25 V		-	657	1314	ns	
Reverse Recovery Charge	Q _{rr}			-	14.6	29.2	μΟ	
Reverse Recovery Current	I _{RRM}			-	34.7	-	A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

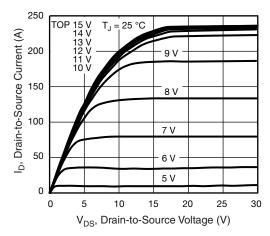


Fig. 1 - Typical Output Characteristics

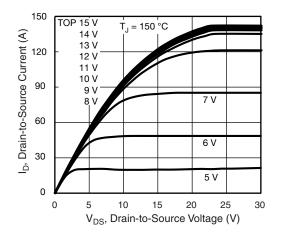


Fig. 2 - Typical Output Characteristics

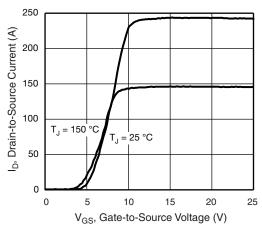


Fig. 3 - Typical Transfer Characteristics

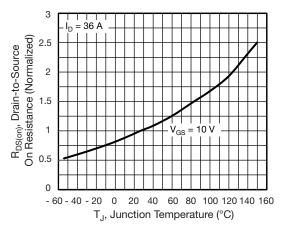


Fig. 4 - Normalized On-Resistance vs. Temperature

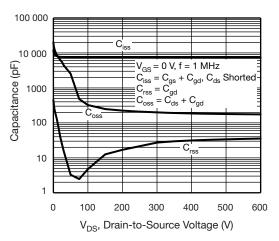


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

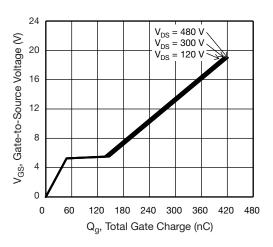


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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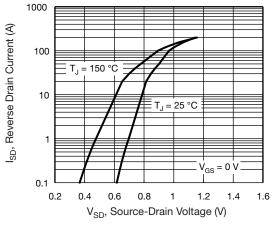
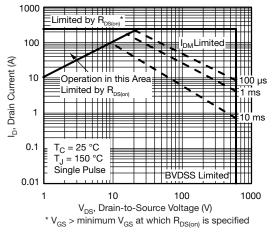


Fig. 7 - Typical Source-Drain Diode Forward Voltage





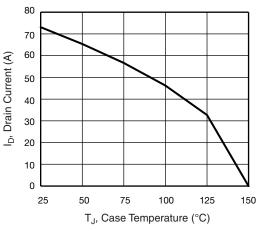


Fig. 9 - Maximum Drain Current vs. Case Temperature

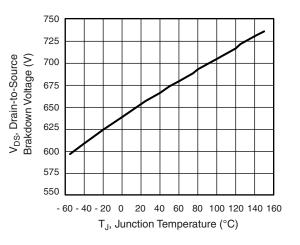
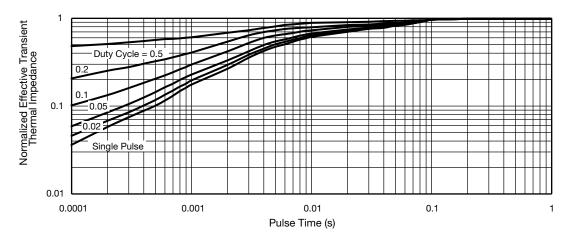


Fig. 10 - Temperature vs. Drain-to-Source Voltage





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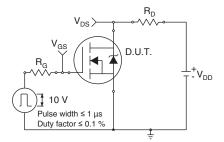


Fig. 12 - Switching Time Test Circuit

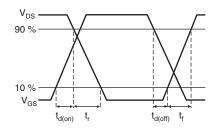


Fig. 13 - Switching Time Waveforms

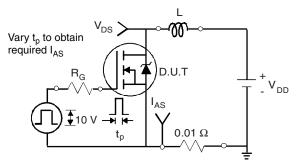


Fig. 14 - Unclamped Inductive Test Circuit

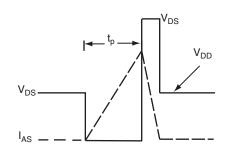


Fig. 15 - Unclamped Inductive Waveforms

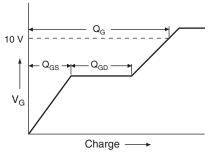


Fig. 16 - Basic Gate Charge Waveform

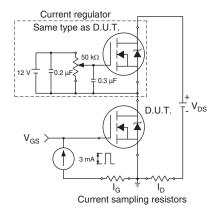


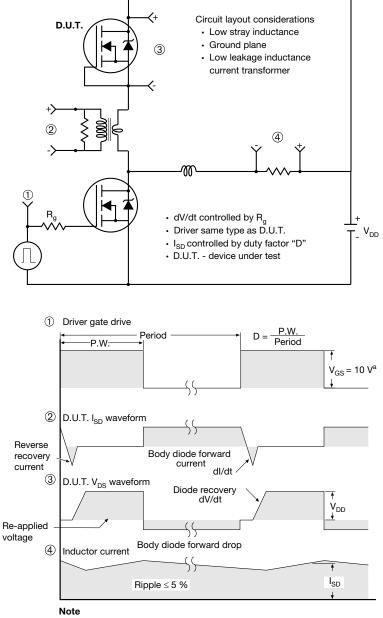
Fig. 17 - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 18 - For N-Channel

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TO-247AC (High Voltage)

ECN: X13-0103-Rev. D, 01-Jul-13 DWG: 5971

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Contour of slot optional.

 Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.

4. Thermal pad contour optional with dimensions D1 and E1.

5. Lead finish uncontrolled in L1.

6. Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154").

7. Outline conforms to JEDEC outline TO-247 with exception of dimension c.

8. Xian and Mingxin actually photo.





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